PD-95470

 I_D

44A

International Rectifier

SMPS MOSFET

 \overline{V}_{DSS}

200V

IRFB42N20DPbF

R_{DS(on)} max

 $\mathbf{0.055}\Omega$

HEXFET® Power MOSFET

Applications

- High frequency DC-DC converters
- Motor Control
- Uninterrutible Power Supplies
- Lead-Free

Benefits

- Low Gate-to-Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective C_{OSS} to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current



Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	44	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	31	Α
I _{DM}	Pulsed Drain Current ①	180	
P _D @T _A = 25°C	Power Dissipation	2.4	W
P _D @T _C = 25°C	Power Dissipation	330	
	Linear Derating Factor	2.2	W/°C
V_{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt 3	2.5	V/ns
T _J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torqe, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case		0.45	
R _{0CS}	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient		62	

Notes ① through ⑤ are on page 8

Static @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	200			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.26		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.055	Ω	$V_{GS} = 10V, I_D = 26A$ ④
V _{GS(th)}	Gate Threshold Voltage	3.0		5.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
I _{DSS}	Drain-to-Source Leakage Current			25	μA	$V_{DS} = 200V, V_{GS} = 0V$
אסטי				250		$V_{DS} = 160V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
	Gate-to-Source Forward Leakage			100	nA ·	V _{GS} = 30V
IGSS	Gate-to-Source Reverse Leakage			-100	11/4	V _{GS} = -30V

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
9fs	Forward Transconductance	21			S	$V_{DS} = 50V, I_{D} = 26A$
Q _g	Total Gate Charge		91	140		I _D = 26A
Q _{gs}	Gate-to-Source Charge		24	36	nC	$V_{DS} = 160V$
Q _{gd}	Gate-to-Drain ("Miller") Charge		43	65		$V_{GS} = 10V$,
t _{d(on)}	Turn-On Delay Time		18			$V_{DD} = 100V$
t _r	Rise Time		69		ns	$I_D = 26A$
t _{d(off)}	Turn-Off Delay Time		29		110	$R_G = 1.8\Omega$
t _f	Fall Time		32			V _{GS} = 10V ④
C _{iss}	Input Capacitance		3430			$V_{GS} = 0V$
Coss	Output Capacitance		530			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		100		pF	f = 1.0MHz
C _{oss}	Output Capacitance		5310]	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance		210]	$V_{GS} = 0V$, $V_{DS} = 160V$, $f = 1.0MHz$
Coss eff.	Effective Output Capacitance		400			V _{GS} = 0V, V _{DS} = 0V to 160V ⑤

Avalanche Characteristics

	Parameter	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy ^②		510	mJ
I _{AR}	Avalanche Current①		26	Α
E _{AR}	Repetitive Avalanche Energy①		33	mJ

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			44		MOSFET symbol
	(Body Diode)				A	showing the
I _{SM}	Pulsed Source Current			180		integral reverse
	(Body Diode) ①				00	p-n junction diode.
V _{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$, $I_S = 26A$, $V_{GS} = 0V$ ④
t _{rr}	Reverse Recovery Time		220	330	ns	$T_J = 25^{\circ}C, I_F = 26A$
Q _{rr}	Reverse RecoveryCharge		1860	2790	nC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)				

International TOR Rectifier

IRFB42N20DPbF

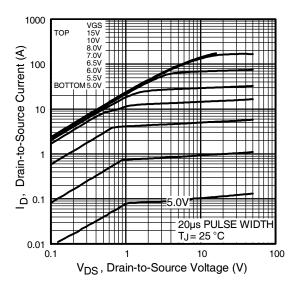


Fig 1. Typical Output Characteristics

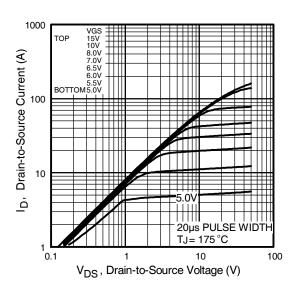


Fig 2. Typical Output Characteristics

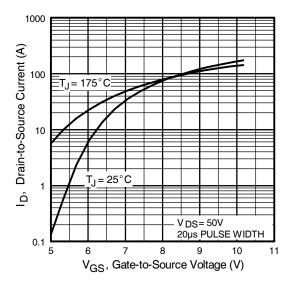


Fig 3. Typical Transfer Characteristics

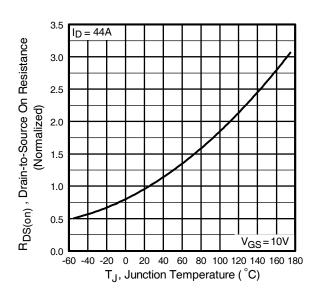


Fig 4. Normalized On-Resistance Vs. Temperature

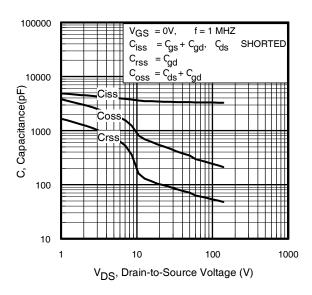


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

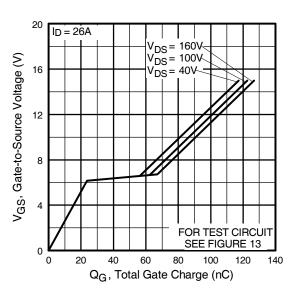


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

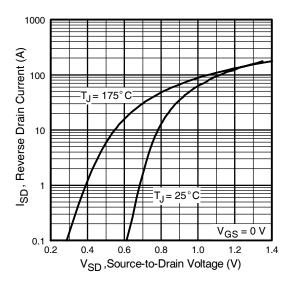


Fig 7. Typical Source-Drain Diode Forward Voltage

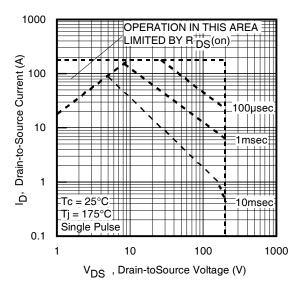


Fig 8. Maximum Safe Operating Area

International TOR Rectifier

IRFB42N20DPbF

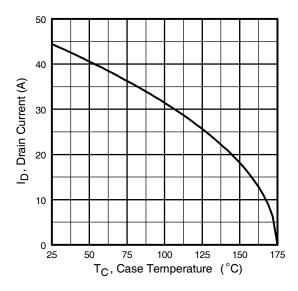


Fig 9. Maximum Drain Current Vs. Case Temperature

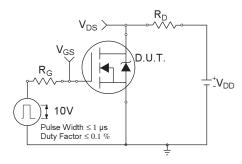


Fig 10a. Switching Time Test Circuit

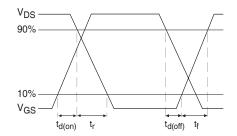


Fig 10b. Switching Time Waveforms

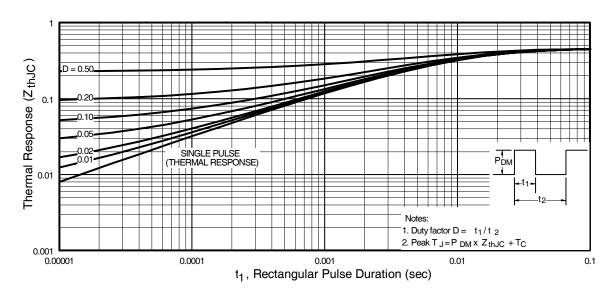


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

International TOR Rectifier

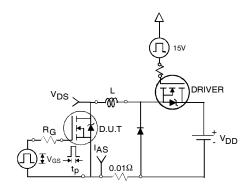


Fig 12a. Unclamped Inductive Test Circuit

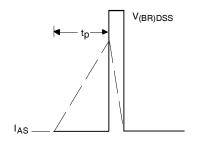


Fig 12b. Unclamped Inductive Waveforms

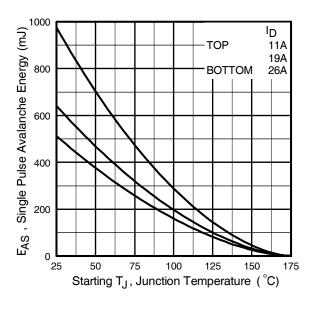


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

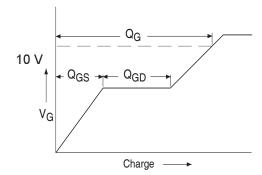


Fig 13a. Basic Gate Charge Waveform

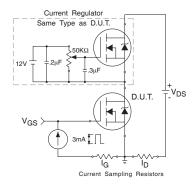
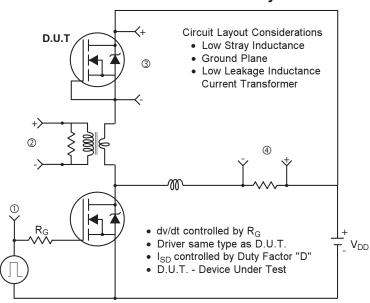
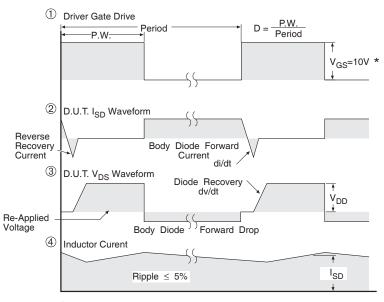


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



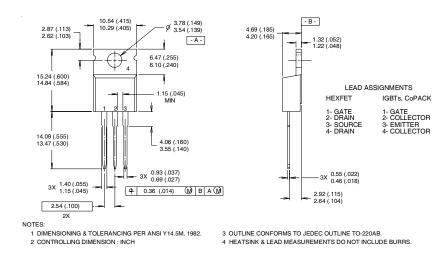


* V_{GS} = 5V for Logic Level Devices

Fig 14. For N-Channel HEXFET® Power MOSFETs



TO-220AB Package Outline

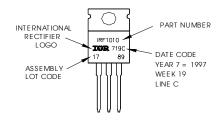


TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789

ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free"



Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^{\circ}C$, L = 1.45mH $R_G = 25\Omega$, $I_{AS} = 26A$, $V_{GS} = 10V$
- $\label{eq:local_spin_spin}$ $\label{eq:local_spin_spin} I_{SD} \leq 26A, \ di/dt \leq 110A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_{J} \leq 175^{\circ}C$
- 4 Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.
- $\ ^{\textcircled{5}}$ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}

Data and specifications subject to change without notice.

This product has been designed and qualified for the Industrial market.

Qualification Standards can be found on IR's Web site.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.7/04 www.irf.com Note: For the most current drawings please refer to the IR website at: http://www.irf.com/package/

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.